

Photocouplers Photorelay

TLP220A

1. Applications

- · Mechanical relay replacements
- · Security Systems
- Measuring Equipment
- Factory Automation (FA)
- · Amusement Equipment
- · Smart Meters
- · Electricity Meters

2. General

The TLP220A photorelay consists of a photo MOSFET optically coupled to an infrared light emitting diode. It is housed in a 4-pin DIP package. It provides an isolation voltage of 5000 Vrms, making it suitable for applications that require reinforced insulation.

3. Features

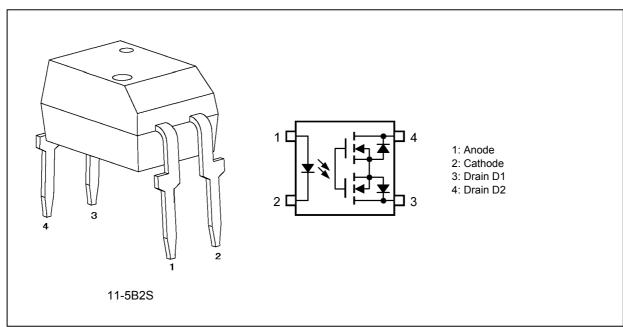
- (1) Normally open (1-Form-A)
- (2) OFF-state output terminal voltage: 60 V (min)
- (3) Trigger LED current: 2 mA (max)
- (4) ON-state current: 500 mA (max)
- (5) ON-state resistance: 2Ω (max)
- (6) Isolation voltage: 5000 Vrms (min)
- (7) Safety standards

UL-under application: UL1577 File No.E67349

 $cUL\mbox{-}under$ application: CSA Component Acceptance Service No.5A, File No.E67349

VDE-under application: Option (D4) EN60747-5-2

4. Packaging and Pin Configuration





5. Internal Circuit

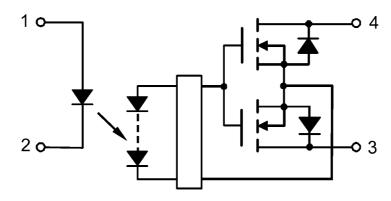


Fig. 5.1 Internal Circuit

6. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25°C)

	Characteristics	Symbol	Note	Rating	Unit	
LED	Input forward current		I _F		30	mA
	Input forward current derating	$(T_a \ge 25^{\circ}C)$	$\Delta I_F/\Delta T_a$		-0.3	mA/°C
	Input forward current (pulsed)	(100 μs pulse, 100 pps)	I _{FP}		1	Α
	Input reverse voltage		V _R		5	V
	Junction temperature		Tj		125	°C
Detector	OFF-state output terminal voltage		V _{OFF}		60	V
	ON-state current		I _{ON}		500	mA
	ON-state current derating	$(T_a \ge 25^{\circ}C)$	Δl _{ON} /ΔT _a		-5	mA/°C
	ON-state current (pulsed)	(t = 100 ms, Duty = 1/10)	I _{ONP}		1.5	Α
	Junction temperature		Tj		125	°C
Common	Storage temperature		T _{stg}		-55 to 125	
	Operating temperature		T _{opr}		-40 to 85	
	Lead soldering temperature	(10 s)	T _{sol}		260	
	Isolation voltage	AC, 1 min, R.H. ≤ 60%	BV _S	(Note 1)	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

7. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Supply voltage	V_{DD}		_	_	48	V
Input forward current	I _F		3	5	15	mA
ON-state current	I _{ON}		_	_	500	
Operating temperature	T _{opr}		-20	_	65	ç

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this datasheet should also be considered.



8. Electrical Characteristics (Unless otherwise specified, T_a = 25°C)

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V _F		I _F = 10 mA	1.45	1.63	1.75	V
	Input reverse current	I _R		V _R = 5 V			10	μΑ
	Input capacitance	Ct		V = 0 V, f = 1 MHz		40		pF
Detector	OFF-state current	I _{OFF}		V _{OFF} = 60 V	_	_	1	μΑ
	Output capacitance	C _{OFF}		V = 0 V, f = 1 MHz	1	130		pF

9. Coupled Electrical Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}		I _{ON} = 500 mA	1	0.3	2	mA
Return LED current	I _{FC}		I _{OFF} = 10 μA	0.1			mA
ON-state resistance	R _{ON}	(Note 1)	I_{ON} = 500 mA, I_F = 5 mA, Continuous		0.6	2	Ω

Note 1: Thermally saturated state.

10. Isolation Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	C _S	(Note 1)	V _S = 0 V, f = 1 MHz		0.8		pF
Isolation resistance	R _S	(Note 1)	V_S = 500 V, R.H. \leq 60%	1×10 ¹²	1014	_	Ω
Isolation voltage	BVS		AC, 1 min	5000		_	Vrms
			AC, 1s in oil	_	10000	_	
			DC, 1 min, in oil	-	10000		Vdc

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

11. Switching Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$)

Characteristics	Symbol	Note	Test Condition	Min	Тур	Max	Unit
Turn-on time	t _{on}		See Fig. 11.1.	_	0.5	1	ms
Turn-off time	t _{off}		$R_L = 200 \Omega$, $V_{DD} = 20 V$, $I_F = 5 mA$	_	0.2	1	

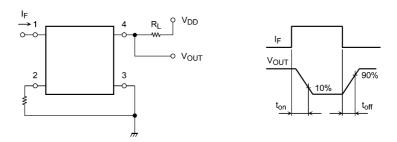


Fig. 11.1 Switching Time Test Circuit

12. Characteristics Curves and Circuit Connections

12.1. Characteristics Curves (Note)

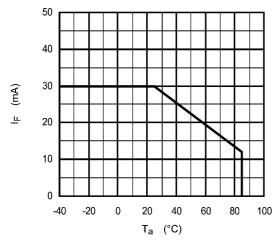


Fig. 12.1.1 $I_F - T_a$

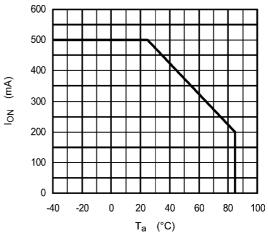


Fig. 12.1.2 I_{ON} - T_a

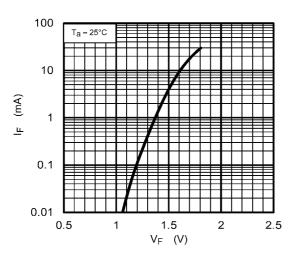


Fig. 12.1.3 I_F - V_F

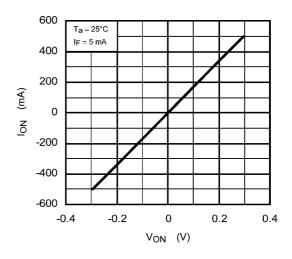


Fig. 12.1.4 I_{ON} - V_{ON}

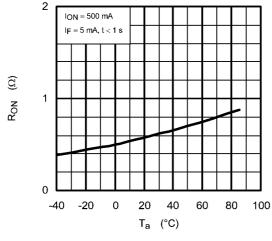


Fig. 12.1.5 R_{ON} - T_a

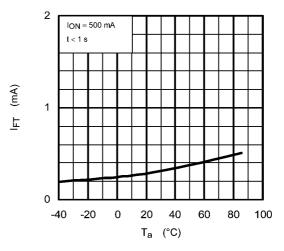


Fig. 12.1.6 I_{FT} - T_a

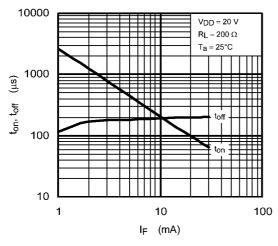


Fig. 12.1.7 t_{on} , t_{off} - I_F

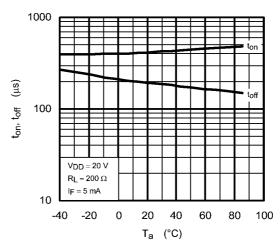


Fig. 12.1.8 t_{on} , t_{off} - T_a

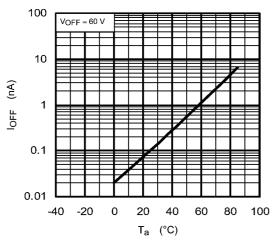


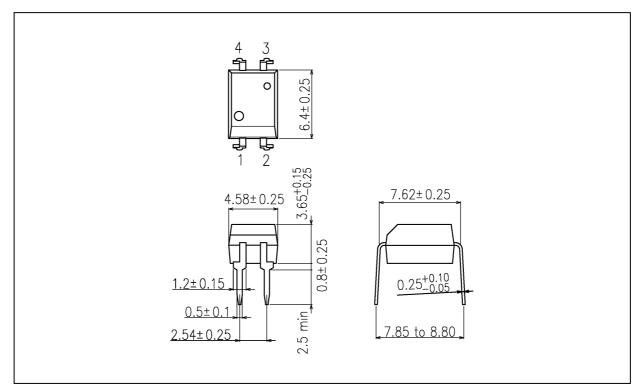
Fig. 12.1.9 I_{OFF} - T_a

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 0.26 g (typ.)

	Package Name(s)
TOSHIBA: 11-5B2S	

Rev.1.0



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